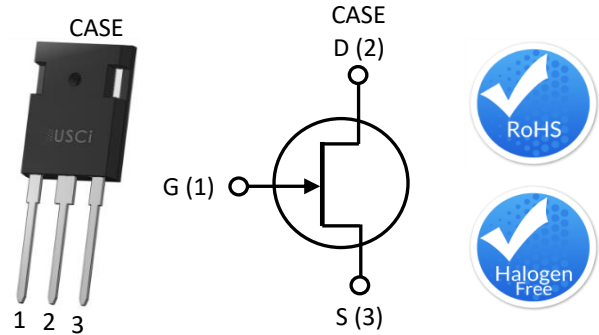


Description

United Silicon Carbide, Inc offers the high-performance G3 SiC normally-on JFET transistors. This series exhibits ultra-low on resistance ($R_{DS(ON)}$) and gate charge (Q_G) allowing for low conduction and switching loss. The device normally-on characteristics with low $R_{DS(ON)}$ at $V_{GS} = 0\text{ V}$ is also ideal for current protection circuits without the need for active control, as well as for cascode operation.



Part Number	Package	Marking
UJ3N065025K3S	TO-247-3L	UJ3N065025K3S

Features

- ◆ Typical on-resistance $R_{DS(on),typ}$ of 25mΩ
- ◆ Voltage controlled
- ◆ Maximum operating temperature of 175°C
- ◆ Extremely fast switching not dependent on temperature
- ◆ Low gate charge
- ◆ Low intrinsic capacitance
- ◆ RoHS compliant

Typical Applications

- ◆ Over current protection circuits
- ◆ DC-AC inverters
- ◆ Switch mode power supplies
- ◆ Power factor correction modules
- ◆ Motor drives
- ◆ Induction heating

Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units
Drain-source voltage	V_{DS}		650	V
Gate-source voltage	V_{GS}	DC	-20 to +3	V
		AC ⁽¹⁾	-20 to +20	
Continuous drain current ⁽²⁾	I_D	$T_C = 25^\circ\text{C}$	85	A
		$T_C = 100^\circ\text{C}$	62	A
Pulsed drain current ⁽³⁾	I_{DM}	$T_C = 25^\circ\text{C}$	250	A
Power dissipation	P_{tot}	$T_C = 25^\circ\text{C}$	441	W
Maximum junction temperature	$T_{J,max}$		175	°C
Operating and storage temperature	T_J, T_{STG}		-55 to 175	°C
Max. lead temperature for soldering, 1/8" from case for 5 seconds	T_L		250	°C

(1) +20V AC rating applies for turn-on pulses <200ns applied with external $R_G > 1\Omega$.

(2) Limited by $T_{J,max}$

(3) Pulse width t_p limited by $T_{J,max}$

Electrical Characteristics ($T_J = +25^\circ\text{C}$ unless otherwise specified)

Typical Performance - Static

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Drain-source breakdown voltage	BV_{DS}	$V_{GS} = -20\text{V}, I_D = 1\text{mA}$	650			V
Total drain leakage current	I_D	$V_{DS} = 650\text{V},$ $V_{GS} = -20\text{V}, T_J = 25^\circ\text{C}$		10	60	μA
		$V_{DS} = 650\text{V},$ $V_{GS} = -20\text{V}, T_J = 175^\circ\text{C}$		40		
Total gate leakage current	I_G	$V_{GS} = -20\text{V}, T_J = 25^\circ\text{C}$		10	100	μA
		$V_{GS} = -20\text{V}, T_J = 175^\circ\text{C}$		38		
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 2\text{V}, I_D = 20\text{A},$ $T_J = 25^\circ\text{C}$		22		$\text{m}\Omega$
		$V_{GS} = 0\text{V}, I_D = 20\text{A},$ $T_J = 25^\circ\text{C}$		25	33	
		$V_{GS} = 2\text{V}, I_D = 20\text{A},$ $T_J = 175^\circ\text{C}$		38		
		$V_{GS} = 0\text{V}, I_D = 20\text{A},$ $T_J = 175^\circ\text{C}$		43		
Gate threshold voltage	$V_{G(th)}$	$V_{DS} = 5\text{V}, I_D = 70\text{mA}$	-14	-11.5	-6	V
Gate resistance	R_G	$f = 1\text{MHz}, \text{open drain}$		2.5		Ω

Typical Performance - Dynamic

Parameter	symbol	Test Conditions	Value			Units	
			Min	Typ	Max		
Input capacitance	C_{iss}	$V_{DS} = 100V,$ $V_{GS} = -20V,$ $f = 100kHz$		2360		pF	
Output capacitance	C_{oss}			290			
Reverse transfer capacitance	C_{rss}			282			
Effective output capacitance, energy related	$C_{oss(er)}$	$V_{DS} = 0V$ to 400V, $V_{GS} = -20V$		210		pF	
Total gate charge	Q_G	$V_{DS}=400V, I_D = 60A,$ $V_{GS}=-18V$ to 0V		240		nC	
Gate-drain charge	Q_{GD}			134			
Gate-source charge	Q_{GS}			24			
Turn-on delay time	$t_{d(on)}$	$V_{DS}=400V, I_D=60A,$ Gate Driver = -18V to 0V, $R_{G,EXT} = 1\Omega,$ Inductive Load, FWD: UJ3D06530TS $T_J = 25^\circ C$		11		ns	
Rise time	t_r			64			
Turn-off delay time	$t_{d(off)}$			43			
Fall time	t_f			44			
Turn-on energy	E_{ON}			740			μJ
Turn-off energy	E_{OFF}			818			
Total switching energy	E_{TOTAL}			1558			
Turn-on delay time	$t_{d(on)}$	$V_{DS}=400V, I_D=60A,$ Gate Driver = -18V to 0V, $R_{G,EXT} = 1\Omega,$ Inductive Load, FWD: UJ3D06530TS $T_J = 150^\circ C$		11		ns	
Rise time	t_r			62			
Turn-off delay time	$t_{d(off)}$			38			
Fall time	t_f			41			
Turn-on energy	E_{ON}			663			μJ
Turn-off energy	E_{OFF}			750			
Total switching energy	E_{TOTAL}			1413			

Thermal Characteristics

Parameter	symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.26	0.34	$^\circ C/W$

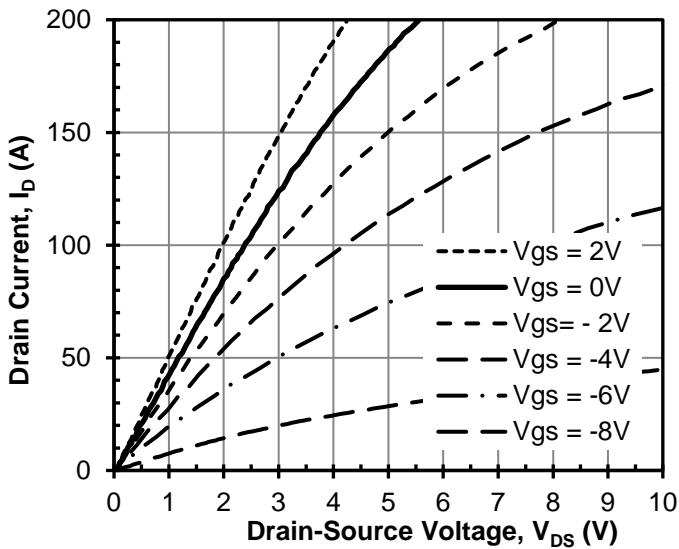
Typical Performance Diagrams


Figure 1 Typical output characteristics
at $T_J = -55^\circ\text{C}$

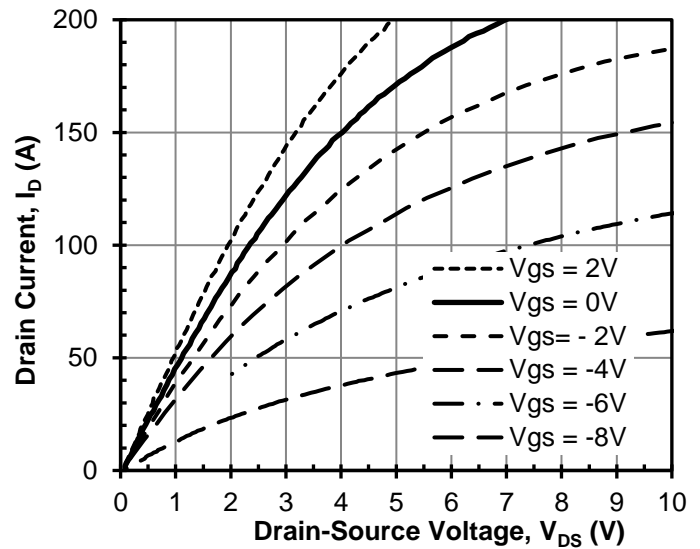


Figure 2 Typical output characteristics
at $T_J = 25^\circ\text{C}$

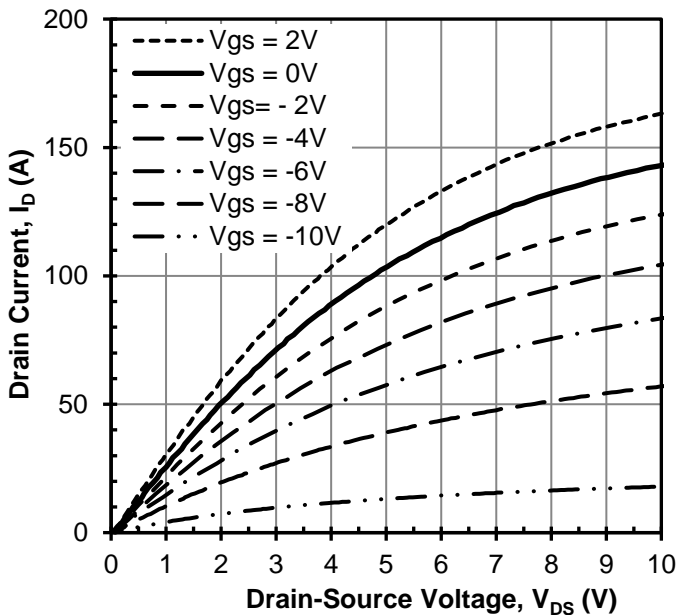


Figure 3 Typical output characteristics
at $T_J = 175^\circ\text{C}$

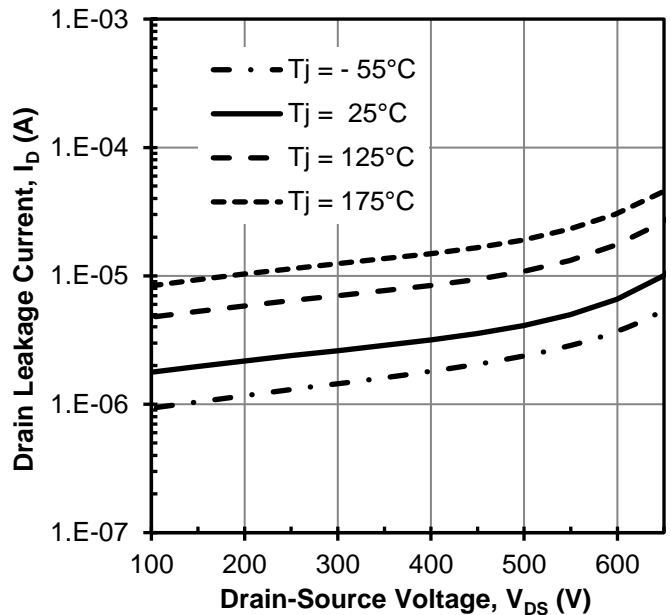


Figure 4 Typical drain-source leakage
at $V_{GS} = -20\text{V}$

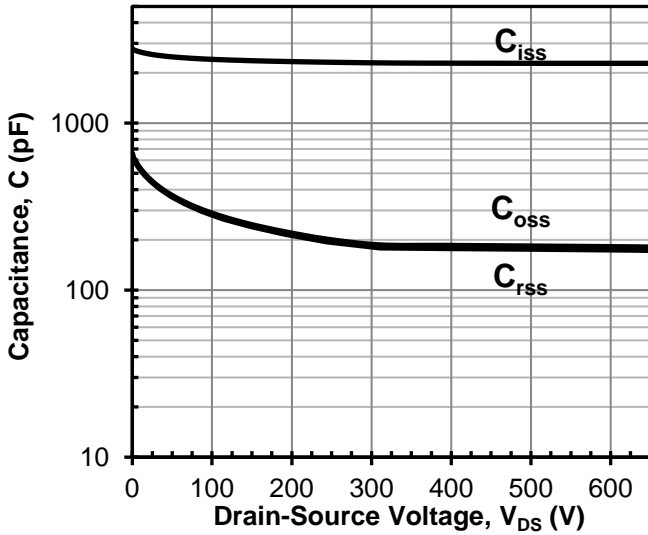


Figure 5 Typical capacitances at 100kHz and $V_{GS} = -20V$

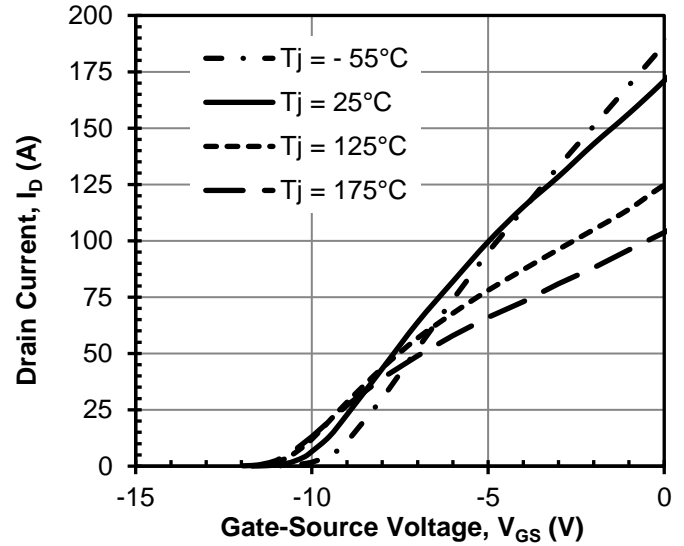


Figure 6 Typical transfer characteristics at $V_{DS} = 5V$

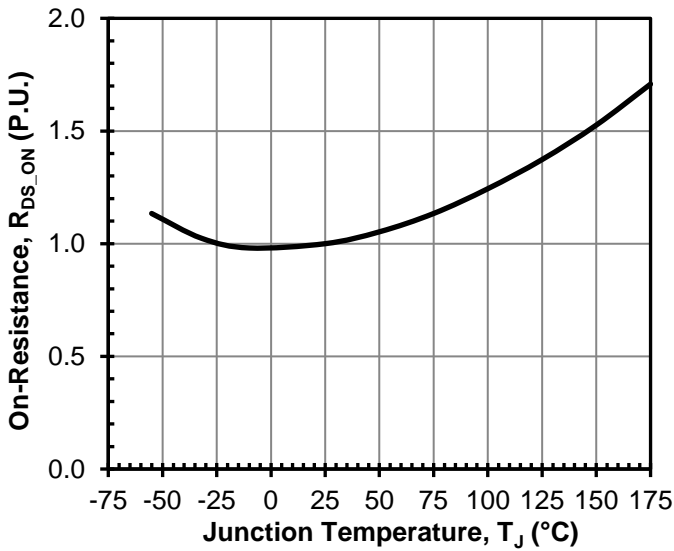


Figure 7 Normalized on-resistance vs. temperature at $V_{GS} = 0V$ and $I_D = 20A$

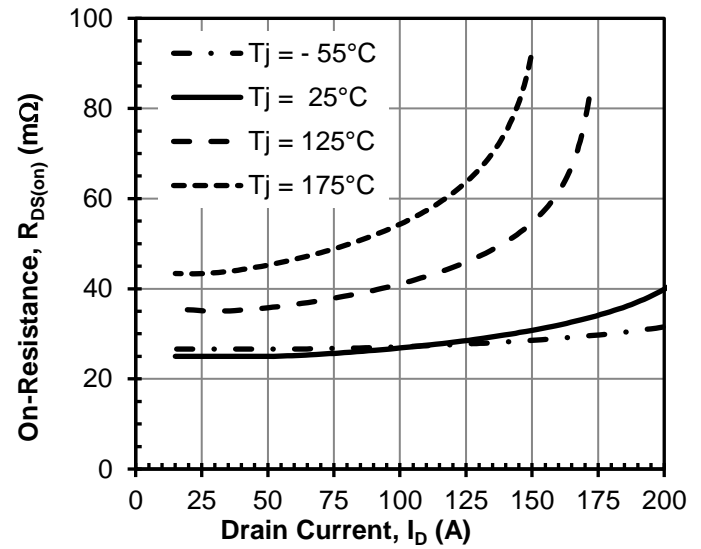


Figure 8 Typical drain-source on-resistance at $V_{GS} = 0V$

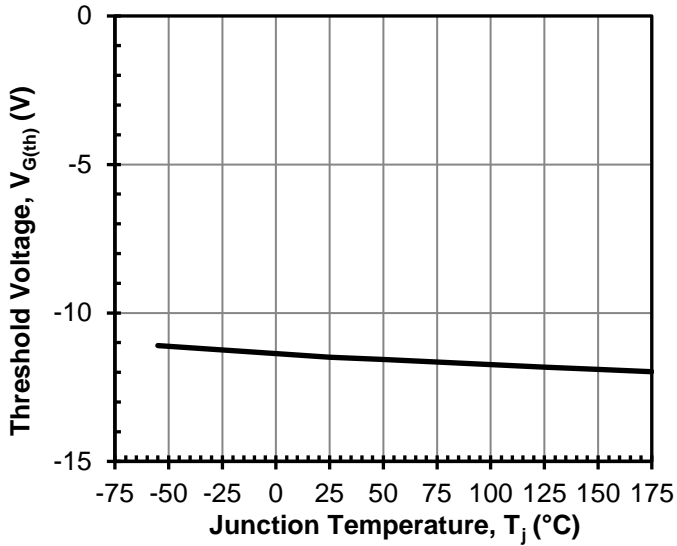


Figure 9 Threshold voltage vs. T_j
at $V_{DS} = 5V$ and $I_D = 70mA$

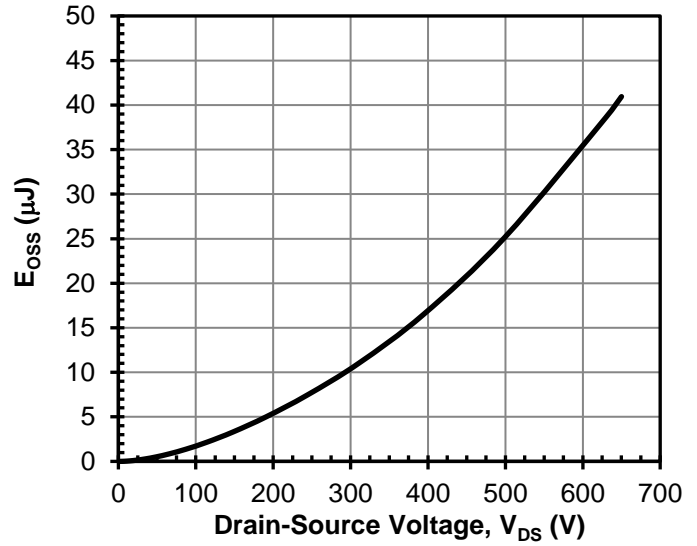


Figure 10 Typical stored energy in C_{oss}
at $V_{GS} = -20V$

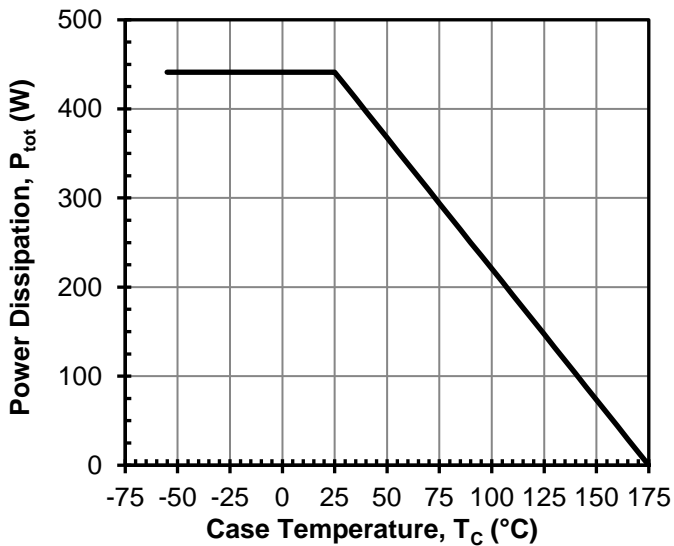


Figure 11 Total power Dissipation

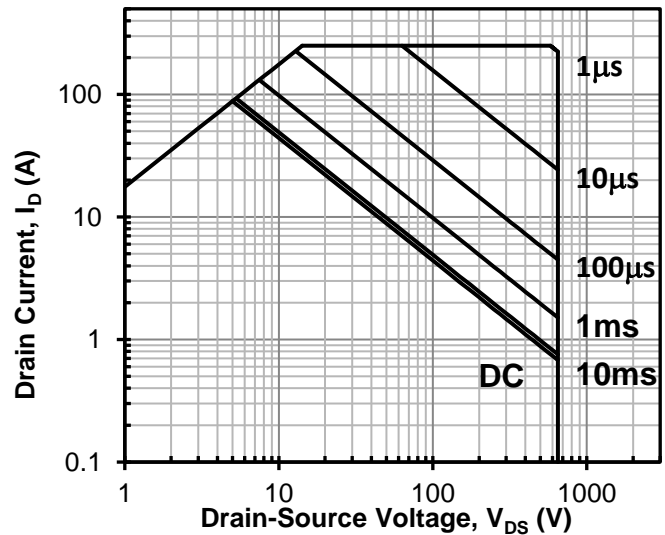


Figure 12 Safe operation area
 $T_c = 25^\circ C$, Parameter t_p

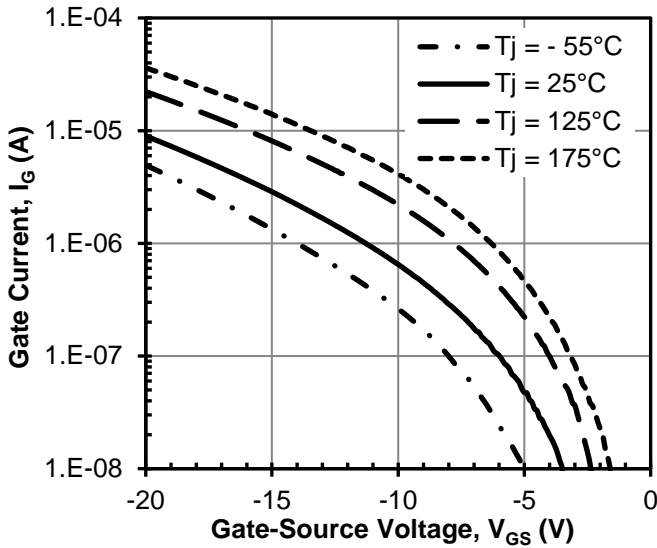


Figure 13 Typical gate leakage current
at $V_{DS} = 0V$

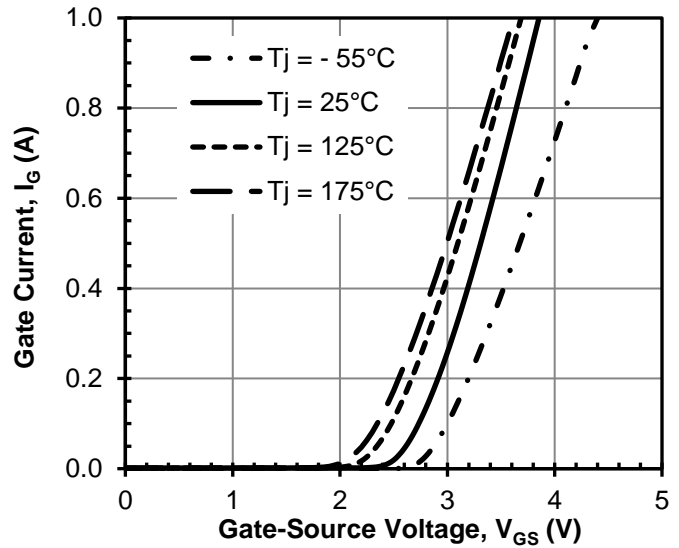


Figure 14 Typical gate forward current
at $V_{DS} = 0V$

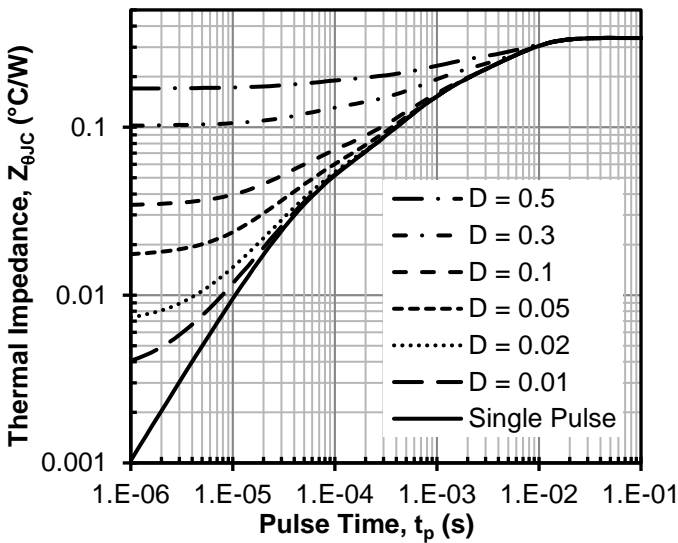


Figure 15 Maximum transient
thermal impedance

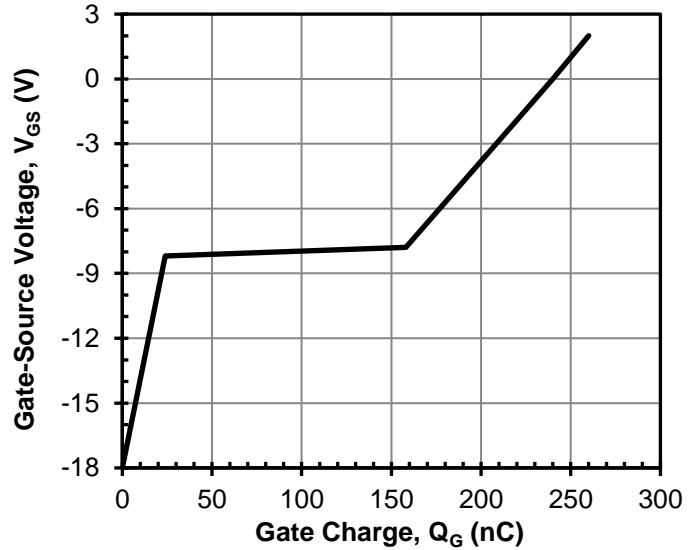


Figure 16 Typical gate charge
at $V_{DS} = 400V$ and $I_D = 60A$

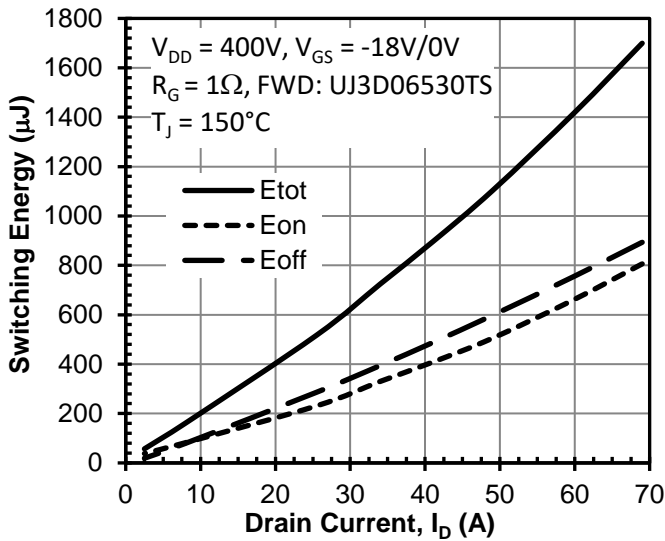


Figure 17 Clamped inductive switching energy vs. drain current at $T_J = 150^\circ\text{C}$

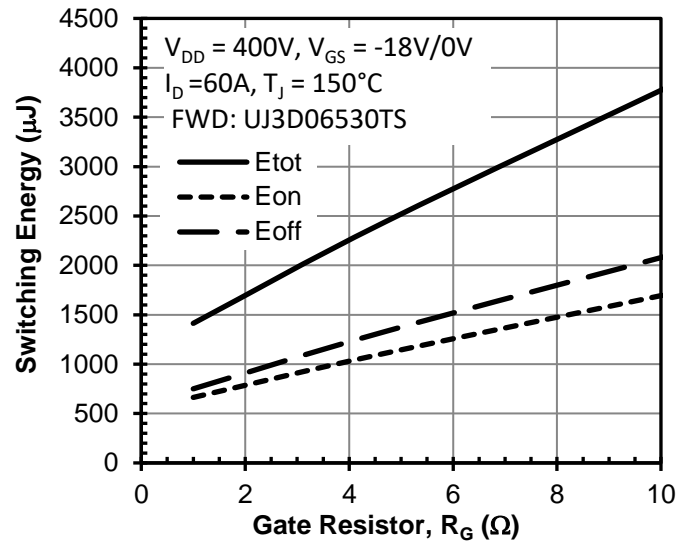


Figure 18 Clamped inductive switching energy vs. gate resistor R_G

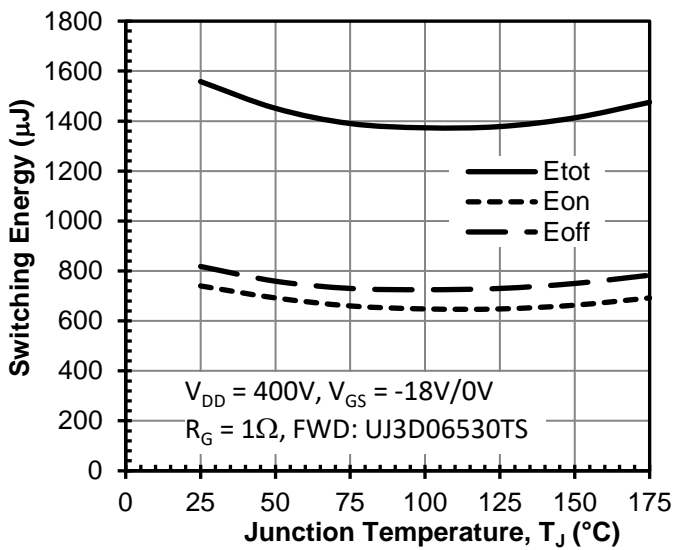


Figure 19 Clamped inductive switching energy vs. junction temperature at $I_D = 60A$

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